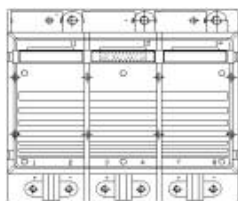


SKiiP 342GD120-3DU



SKiiP® 2

6-pack - integrated intelligent Power System

Power section

SKiiP 342GD120-3DU

Features

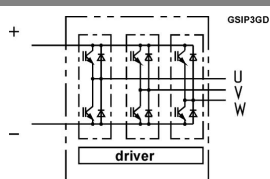
- SKiiP technology inside
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP® 2 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532

1) with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)

Absolute Maximum Ratings		$T_s = 25^\circ\text{C}$ unless otherwise specified	
Symbol	Conditions	Values	Units
IGBT			
V_{CES}	Operating DC link voltage	1200	V
$V_{CC}^{1)}$		900	V
V_{GES}		± 20	V
I_C	$T_s = 25 (70)^\circ\text{C}$	300 (225)	A
Inverse diode			
$I_F = -I_C$	$T_s = 25 (70)^\circ\text{C}$	300 (225)	A
I_{FSM}	$T_j = 150^\circ\text{C}$, $t_p = 10\text{ ms}$; sin.	2160	A
I^2t (Diode)	Diode, $T_j = 150^\circ\text{C}$, 10 ms	23	kA ² s
$T_j, (T_{stg})$	AC, 1 min. (mainterminals to heat sink)	- 40 (- 25) ... + 150 (125)	$^\circ\text{C}$
V_{isol}		3000	V

Characteristics		T _s = 25 °C unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
V _{CESat}	I _C = 250 A, T _j = 25 (125) °C		2,6 (3,1)	3,1	V
V _{CEO}	T _j = 25 (125) °C		1,2 (1,3)	1,5 (1,6)	V
r _{CE}	T _j = 25 (125) °C		5,3 (7)	6,3 (8,1)	mΩ
I _{CES}	V _{GE} = 0 V, V _{CE} = V _{CES} , T _j = 25 (125) °C		(15)	0,4	mA
E _{on} + E _{off}	I _C = 250 A, V _{CC} = 600 V			75	mJ
	T _j = 125 °C, V _{CC} = 900 V			132	mJ
R _{CC' + EE'}	terminal chip, T _j = 125 °C		0,5		mΩ
L _{CE}	top, bottom		15		nH
C _{CHC}	per phase, AC-side		1,4		nF
Inverse diode					
V _F = V _{EC}	I _F = 250 A, T _j = 25 (125) °C		2,1 (2)	2,6	V
V _{TO}	T _j = 25 (125) °C		1,3 (1)	1,4 (1,1)	V
r _T	T _j = 25 (125) °C		3,3 (4)	4,5 (5,2)	mΩ
E _{rr}	I _C = 250 A, V _{CC} = 600 V			10	mJ
	T _j = 125 °C, V _{CC} = 900 V			12	mJ
Mechanical data					
M _{dc}	DC terminals, SI Units	6		8	Nm
M _{ac}	AC terminals, SI Units	13		15	Nm
w	SKiiP® 2 System w/o heat sink		2,7		kg
w	heat sink		6,6		kg

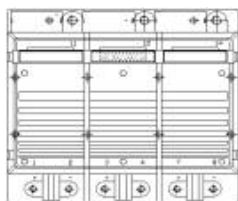
Thermal characteristics (P16 heat sink; 295 m ³ /h); "r" reference to temperature sensor					
$R_{th(j-s)I}$	per IGBT			0,09	K/W
$R_{th(j-s)D}$	per diode			0,25	K/W
$R_{th(s-a)}$	per module			0,036	K/W
Z_{th}	R_i (mK/W) (max. values)	$\tau_{th}(s)$			
	1 2 3 4	1	2	3	4
$Z_{th(j-r)I}$	10 69 11 0	1	0,13	0,001	1
$Z_{th(j-r)D}$	28 193 30 0	1	0,13	0,001	1
$Z_{th(r-a)}$	11,1 18,3 3,5 3,1	204	60	6	0,02



Case S 3

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SKiiP 342GD120-3DU



SKiiP® 2

6-pack - integrated intelligent Power System

6-pack
integrated gate driver

SKiiP 342GD120-3DU

Gate driver features

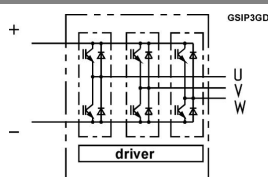
- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- Interlock of top/bottom switch
- Isolation by transformer
- IEC 60068-1 (climate) 25/85/56

Absolute Maximum Ratings		$T_a = 25\text{ °C}$ unless otherwise specified	
Symbol	Conditions	Values	Units
V_{S1}	stabilized 15 V power supply	18	V
V_{S2}	unstabilized 24 V power supply	30	V
V_{iH}	input signal voltage (high)	$15 + 0,3$	V
dv/dt	secondary to primary side	75	kV/ μ s
V_{isolIO}	input / output (AC, r.m.s., 2s)	3000	Vac
V_{isol12}	output 1 / output 2 (AC, r.m.s., 2s)	1500	Vac
f_{sw}	switching frequency	20	kHz
f_{out}	output frequency for $I = I_C$; sin.	1	kHz
$T_{op} (T_{stg})$	operating / storage temperature	$-40 \dots +85$	$^{\circ}\text{C}$

Characteristics		(T _a = 25 °C)			
Symbol	Conditions	min.	typ.	max.	Units
V _{S1}	supply voltage stabilized	14,4	15	15,6	V
V _{S2}	supply voltage non stabilized	20	24	30	V
I _{S1}	V _{S1} = 15 V	410+550*f/f _{max} +3,6*(I _{AC} /A)			mA
I _{S2}	V _{S2} = 24 V	300+390*f/f _{max} +2,6*(I _{AC} /A)			mA
V _{IT+}	input threshold voltage (High)	12,3			V
V _{IT-}	input threshold voltage (Low)	4,6			V
R _{IN}	input resistance	10			kΩ
t _{d(on)IO}	input-output turn-on propagation time	1,5			μs
t _{d(off)IO}	input-output turn-off propagation time	1,4			μs
t _{pERRRESET}	error memory reset time	9	μs		
t _{TD}	top / bottom switch : interlock time	2,3			μs
I _{analogOUT}	8 V corresponds to max. current of 15 V supply voltage (available when supplied with 24 V)	300			A
I _{Vs1outmax}	output current at pin 13/20/22/24/26	50			mA
I _{A0max}	output current at pin 13/20/22/24/26	5			mA
V _{0l}	logic low output voltage	0,6			V
V _{0H}	logic high output voltage	30			V
I _{TRIPSC}	over current trip level (I _{analog OUT} = 10 V)	375			A
I _{TRIPLG}	ground fault protection	87			A
T _{tp}	over temperature protection	110	120		°C
U _{DCTRIP}	trip level of U _{DC} -protection (U _{analog OUT} = 9 V); (option)	900			V

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